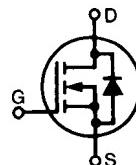


# HiPerRF™ Power MOSFETs F-Class: MegaHertz Switching

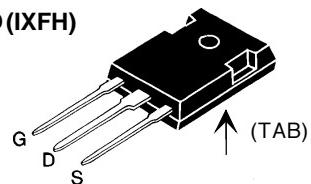
N-Channel Enhancement Mode

Avalanche Rated, Low  $Q_g$ , Low Intrinsic  $R_g$   
High  $dV/dt$ , Low  $t_{rr}$ 

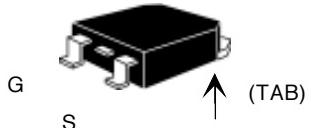
**IXFH 28N50F**       $V_{DSS} = 500V$   
**IXFT 28N50F**       $I_{D25} = 28A$   
 $R_{DS(on)} = 190m\Omega$

 $t_{rr} \leq 250 \text{ ns}$ 

TO-247 AD (IXFH)



TO-268 (IXFT) Case Style



G = Gate,  
S = Source,  
TAB = Drain

Symbol	Test Conditions	Maximum Ratings		
$V_{DSS}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$	500	V	
$V_{DGR}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GS} = 1 \text{ M}\Omega$	500	V	
$V_{GS}$	Continuous	$\pm 20$	V	
$V_{GSM}$	Transient	$\pm 30$	V	
$I_{D25}$	$T_C = 25^\circ\text{C}$	28	A	
$I_{DM}$	$T_C = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$	112	A	
$I_{AR}$	$T_C = 25^\circ\text{C}$	28	A	
$E_{AR}$	$T_C = 25^\circ\text{C}$	35	mJ	
$E_{AS}$	$T_C = 25^\circ\text{C}$	1.5	J	
$dv/dt$	$I_S \leq I_{DM}$ , $di/dt \leq 100 \text{ A}/\mu\text{s}$ , $V_{DD} \leq V_{DSS}$ $T_J \leq 150^\circ\text{C}$ , $R_G = 2 \Omega$	10	V/ns	
$P_D$	$T_C = 25^\circ\text{C}$	315	W	
$T_J$		-55 ... +150	$^\circ\text{C}$	
$T_{JM}$		150	$^\circ\text{C}$	
$T_{stg}$		-55 ... +150	$^\circ\text{C}$	
$T_L$	1.6 mm (0.063 in.) from case for 10 s	300	$^\circ\text{C}$	
$M_d$	Mounting torque	TO-247	1.13/10 Nm/lb.in.	
Weight		TO-247 TO-268	6 g 4 g	

Symbol	Test Conditions	Characteristic Values			
		( $T_J = 25^\circ\text{C}$ , unless otherwise specified)	min.	typ.	max.
$V_{DSS}$	$V_{GS} = 0 \text{ V}$ , $I_D = 1 \text{ mA}$	500			V
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 4 \text{ mA}$	2.0		4.0	V
$I_{GSS}$	$V_{GS} = \pm 20 \text{ V}$ , $V_{DS} = 0$			$\pm 100 \text{ nA}$	
$I_{DSS}$	$V_{DS} = V_{DSS}$ $V_{GS} = 0 \text{ V}$			50 $\mu\text{A}$ 1.5 mA	
$R_{DS(on)}$	$V_{GS} = 10 \text{ V}$ , $I_D = 0.5 I_{D25}$ Note 1			190 $\text{m}\Omega$	

**Features**

- RF capable MOSFETs
- Double metal process for low gate resistance
- Unclamped Inductive Switching (UIS) rated
- Low package inductance - easy to drive and to protect
- Fast intrinsic rectifier

**Applications**

- DC-DC converters
- Switched-mode and resonant-mode power supplies, >500kHz switching
- DC choppers
- 13.5 MHz industrial applications
- Pulse generation
- Laser drivers
- RF amplifiers

**Advantages**

- Space savings
- High power density

Symbol	Test Conditions	Characteristic Values			
		(T <sub>J</sub> = 25°C, unless otherwise specified)	min.	typ.	max.
$g_{fs}$	$V_{DS} = 10 \text{ V}$ ; $I_D = 0.5 \text{ } I_{D25}$	Note 1	12	18	S
$C_{iss}$	$V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1 \text{ MHz}$		3000	pF	
$C_{oss}$			500	pF	
$C_{rss}$			130	pF	
$t_{d(on)}$	$V_{GS} = 10 \text{ V}$ , $V_{DS} = 0.5 \text{ } V_{DSS}$ , $I_D = 0.5 \text{ } I_{D25}$		15	ns	
$t_r$			13	ns	
$t_{d(off)}$			41	ns	
$t_f$			8	ns	
$Q_{g(on)}$	$V_{GS} = 10 \text{ V}$ , $V_{DS} = 0.5 \text{ } V_{DSS}$ , $I_D = 0.5 \text{ } I_{D25}$		95	nC	
$Q_{gs}$			20	nC	
$Q_{gd}$			38	nC	
$R_{thJC}$				0.39	K/W
$R_{thCK}$	(TO-247)		0.25		K/W

## Source-Drain Diode

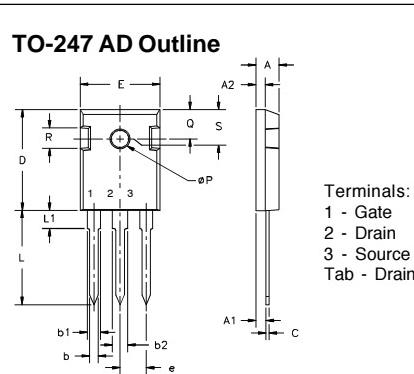
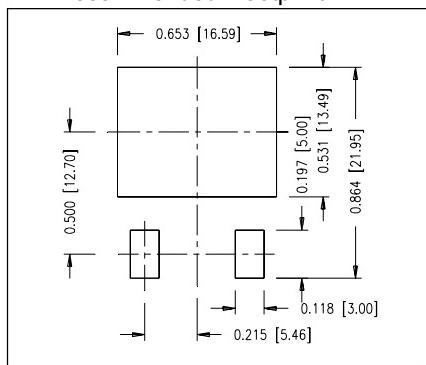
### **Characteristic Values**

( $T_1 = 25^\circ\text{C}$ , unless otherwise specified)

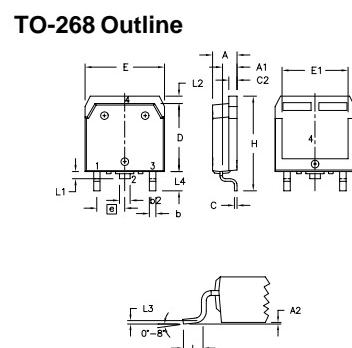
Symbol	Test Conditions	min.	typ.	max.
$I_s$	$V_{GS} = 0 \text{ V}$		28	A
$I_{SM}$	Repetitive; pulse width limited by $T_{JM}$		112	A
$V_{SD}$	$I_F = I_s, V_{GS} = 0 \text{ V}$ , Note 1		1.5	V
$t_{rr}$	$I_F = I_s, -di/dt = 100 \text{ A}/\mu\text{s}, V_R = 100 \text{ V}$		250	ns
$Q_{RM}$		1.0		$\mu\text{C}$
$I_{RM}$		12		A

Note: 1. Pulse test,  $t \leq 300 \mu\text{s}$ , duty cycle  $d \leq 2 \%$

### Min Recommended Footprint



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.7	5.3	.185	.209
A <sub>1</sub>	2.2	2.54	.087	.102
A <sub>2</sub>	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b <sub>1</sub>	1.65	2.13	.065	.084
b <sub>2</sub>	2.87	3.12	.113	.123
C	4	8	.016	.031
D	20.80	21.46	.819	.845
E	15.75	16.26	.610	.640
e	5.20	5.72	0.205	0.225
L	19.81	20.32	.780	.800
L1		4.50		.177
ØP	3.55	3.65	.140	.144
Q	5.89	6.40	0.232	0.252
R	4.32	5.49	.170	.216
S	6.15	BSC	242	BSC



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.9	5.1	.193	.201
$A_1$	2.7	2.9	.106	.114
$A_2$	.02	.25	.001	.010
b	1.15	1.45	.045	.057
$b_2$	1.9	2.1	.75	.83
C	.4	.65	.016	.026
D	13.80	14.00	.543	.551
E	15.85	16.05	.624	.632
$E_1$	13.3	13.6	.524	.535
e	5.45 BSC		.215 BSC	
H	18.70	19.10	.736	.752
L	2.40	2.70	.094	.106
L1	1.20	1.40	.047	.055
L2	1.00	1.15	.039	.045
L3	0.25 BSC		.010 BSC	
L4	3.80	4.10	.150	.161

IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:

4,835,592	4,881,106	5,017,508
4,850,072	4,931,844	5,034,790

5,049,961	5,187,117	5,486,715	6,306,728B1
5,063,307	5,237,481	5,381,025	